

# **DATA SHEET**

Order code	Manufacturer code	Description
47-0538	n/a	STGW30NC120HD IGBT N 1200V 30A TO-247 RC

	Page 1 of
The enclosed information is believed to be correct, Information may change 'without notice' due to	Revision A <sup>14</sup>
product improvement. Users should ensure that the product is suitable for their use. E. & O. E.	12/12/2006

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### STGW30NC120HD

N-channel 1200V - 30A - TO-247 Very fast PowerMESH™ IGBT

#### **General features**

Туре	V <sub>CES</sub>	V <sub>CE(sat)</sub> @25°C	I <sub>C</sub> @100°C
STGW30NC120HD	1200V	< 2.75V	30A

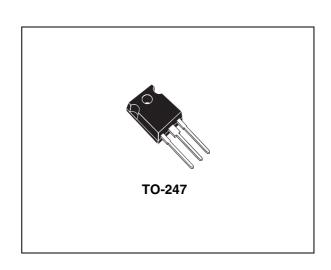
- Low on-losses
- Low on-voltage drop(V<sub>cesat</sub>)
- High current capability
- High input impedance(voltage driven)
- Low gate charge
- Ideal for soft switching application



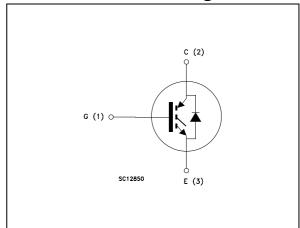
Using the latest high voltage technology based on its patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, with outstanding performances. The suffix "H" identifies a family optimized for high frequency application in order to achieve very high switching performances (reduced tfall) mantaining a low voltage drop.

#### **Applications**

■ Induction heating



#### Internal schematic diagram



#### **Order codes**

Part number	Part number Marking		Packaging	
STGW30NC120HD	GW30NC120HD	TO-247	Tube	

Contents STGW30NC120HD

### **Contents**

1	Electrical ratings
2	Electrical characteristics
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3	Test circuit
4	Package mechanical data
5	Revision history

STGW30NC120HD Electrical ratings

## 1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>GS</sub> = 0)	1200	V
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 25°C	60	Α
I <sub>C</sub> <sup>(1)</sup>	Collector current (continuous) at 100°C	30	Α
I <sub>CL</sub> <sup>(2)</sup>	Collector current (pulsed)	135	Α
V <sub>GE</sub>	Gate-emitter voltage	±25	V
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25°C	220	W
I <sub>f</sub>	Diode RMS forward current at T <sub>C</sub> = 25°C	30	Α
T <sub>j</sub>	Operating junction temperature	-55 to 150	°C
T <sub>stg</sub>	Storage temperature	-33 10 130	

<sup>1.</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX}^{-T}C}{R_{THJ-C}^{\times V}CESAT(MAX)^{(T}C, \ I_{C})}$$

2. Vclamp=960V, Tj=125°C,  $R_G$ =10 $\Omega$ ,  $V_{GE}$ =15V

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.57	°C/W
Rthj-amb	Thermal resistance junction-ambient (diode)	1.6	°C/W
Rthj-amb	Thermal resistance junction-ambient (IGBT)	50	°C/W

Electrical characteristics STGW30NC120HD

## 2 Electrical characteristics

 $(T_{CASE}=25^{\circ}C \text{ unless otherwise specified})$ 

Table 3. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>BR(CES)</sub>	Collector-emitter breakdown voltage	I <sub>C</sub> = 1mA, V <sub>GE</sub> = 0	1200			٧
V <sub>CE(SAT)</sub>	Collector-emitter saturation voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 20A, Tj= 25°C		2.2	2.75	V
	voltage	V <sub>GE</sub> = 15V, I <sub>C</sub> = 20A, Tj=125°C		2.0		V
V <sub>GE(th)</sub>	Gate threshold voltage	$V_{CE} = V_{GE}$ , $I_{C} = 250 \mu A$	3.75		5.75	V
I <sub>CES</sub>	Collector-emitter leakage	V <sub>GE</sub> =Max rating,Tc=25°C			500	μΑ
CES	current (V <sub>CE</sub> = 0)	V <sub>GE</sub> =Max rating, Tc=125°C			10	mA
I <sub>GES</sub>	Gate-emitter leakage current (V <sub>CE</sub> = 0)	V <sub>GE</sub> =± 20V , V <sub>CE</sub> = 0			± 100	nA
9 <sub>fs</sub>	Forward transconductance	$V_{CE} = 25V_{,} I_{C} = 20A$		14		S

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>ies</sub> C <sub>oes</sub> C <sub>res</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>CE</sub> = 25V, f = 1 MHz, V <sub>GE</sub> =0		2510 175 30		pF pF pF
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Total gate charge Gate-emitter charge Gate-collector charge	V <sub>CE</sub> = 960V, I <sub>C</sub> = 20A,V <sub>GE</sub> =15V		110 16 49	120	nC nC nC

Table 5. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{J}$ =25°C (see Figure 16)		29 11 1820		ns ns A/µs
t <sub>d(on)</sub> t <sub>r</sub> (di/dt) <sub>on</sub>	Turn-on delay time Current rise time Turn-on current slope	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 16)		27 14 1580		ns ns A/µs
$t_{\rm r}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 25°C (see Figure 16)		90 275 312		ns ns ns
$t_{\rm r}({\rm V}_{\rm off}) \\ t_{\rm d}(_{\rm off}) \\ t_{\rm f}$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ , $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 16)		150 336 592		ns ns ns

Table 6. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon <sup>(1)</sup> $E_{off}$ $E_{ts}$	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 25°C (see Figure 16)		1660 4438 6098		μJ μJ μJ
Eon <sup>(1)</sup> $E_{off}$ $E_{ts}$	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC}$ = 960V, $I_{C}$ = 20A $R_{G}$ = 10 $\Omega$ $V_{GE}$ = 15V, $T_{J}$ = 125°C (see Figure 16)		3015 6900 9915		μJ μJ μJ

Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)

Table 7. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{f}$	Forward on-voltage	If = 20A, Tj = 25°C		1.9	2.5	٧
'		If = 20A, Tj = 125°C		1.7		V
t <sub>rr</sub>	Reverse recovery time	If = $20A$ , $V_R = 27V$ ,		152		ns
$Q_{rr}$	Reverse recovery charge	$T_i = 125^{\circ}C$ , di/dt = 100A/ $\mu$ s		722		nC
I <sub>rrm</sub>	Reverse recovery current	(see Figure 19)		9		Α

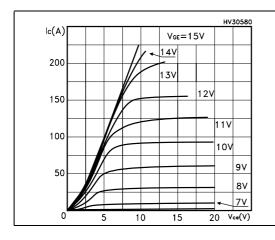
<sup>2.</sup> Turn-off losses include also the tail of the collector current

Electrical characteristics STGW30NC120HD

### 2.1 Electrical characteristics (curves)

Figure 1. Output characterisics

Figure 2. Transfer characteristics



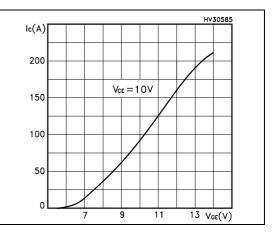
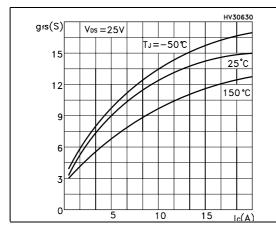


Figure 3. Transconductance

Figure 4. Collector-emitter on voltage vs temperature



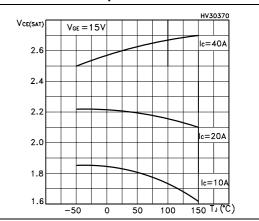
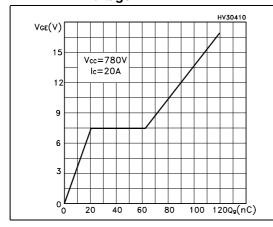


Figure 5. Gate charge vs gate-source voltage

Figure 6. Capacitance variations



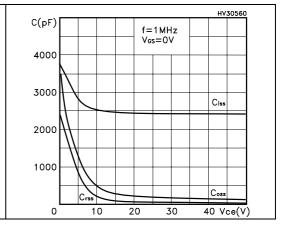


Figure 7. Normalized gate threshold voltage vs temperature

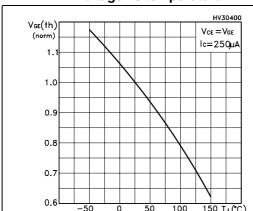


Figure 8. Collector-emitter on voltage vs collector current

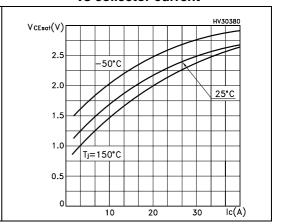


Figure 9. Normalized breakdown voltage vs temperature

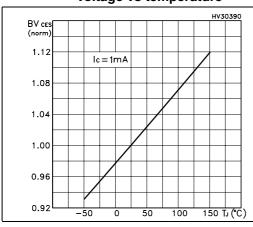


Figure 10. Switching losses vs temperature

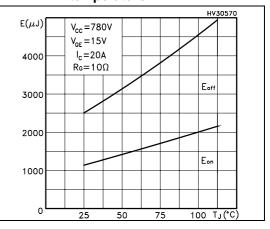
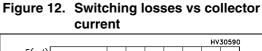
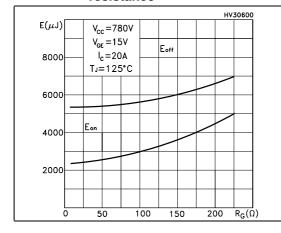
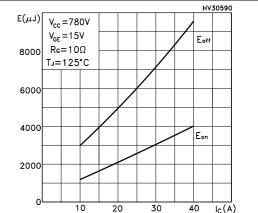


Figure 11. Switching losses vs gate resistance



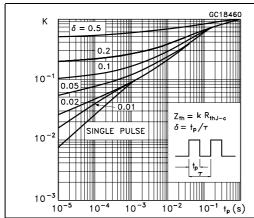




Electrical characteristics STGW30NC120HD

Figure 13. Thermal Impedance

Figure 14. Turn-off SOA



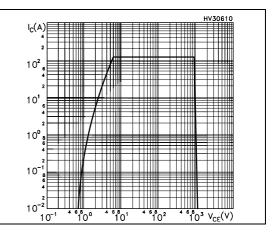
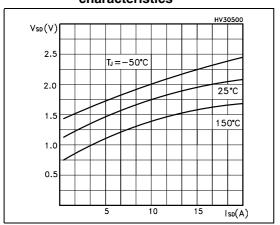


Figure 15. Emitter-collector diode characteristics



STGW30NC120HD Test circuit

### 3 Test circuit

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

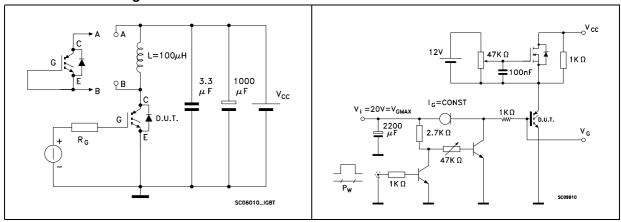
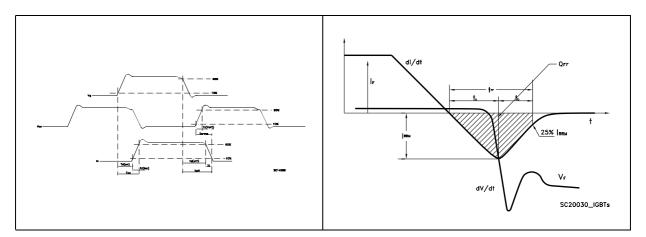


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform



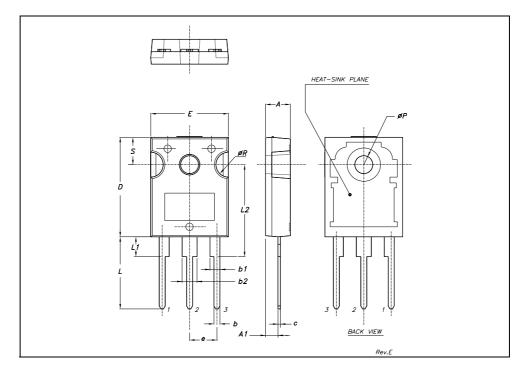
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### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

#### **TO-247 MECHANICAL DATA**

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



Revision history STGW30NC120HD

# 5 Revision history

Table 8. Revision history

Date	Revision	Changes	
23-Nov-2005	1	First issue.	
17-Mar-2006	2	Complete version	
05-May-2006	3	Modified value on Table 1.: Absolute maximum ratings	
30-May-2006	4	New values on Table 2: Thermal resistance	
23-Jun-2006	5	Modified value on Table 3.: Static	
07-Sep-2006	6	Modified T <sub>J</sub> temperature range to 150°C in Table 1.: Absolute maximum ratings	
14-Nov-2006	7	Modified Figure 4. and Figure 8.	

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